

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PSE Technology Corporation SPECIFICATION FOR APPROVAL

37.400000 MHz
TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL
FL374WFMR1
June 17, 2016
A

APPROVED	PREPARED	QA
Brenda	Nikli Lu	Dong Jang
APPROVED BY	AVL Status	
Please return one copy v	vith approval to PSE-TW	

PSE Technology Corporation

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http://www.saronix-ecera.com.tw

*Pb-free

*RoHS Compliant

*HF-Halogen Free

*REACH Compliant



*** A company of PERICOM Semiconductor Corporation ***

Pericom Internal Reference NO. FL3740019Z

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FL374WFMR1

VER. A 17-Jun-16

VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
Α	Jun.17,2016			Initial Release	

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ELECTRICAL SPECIFICATIONS

Symbol	Specifications	Units	Notes
Fn	37.400000	MHz	
MO	AT Cut-Fundamental		
CL	8	pF	
FL	±10	ppm	at 25°C±3°C
TR	-30 to +85	°C	
F/T	±10	ppm	Reference to the Frequency at 25°C
	10	μW	
	150	μW	
ESR	30	Ω	Max
C0	5	pF	Max
	±3	ppm	Max, 1st year
	-55 to +125	°C	
	500	ΜΩ	Min
	Fn MO CL FL TR F/T ESR	Fn 37.400000 MO AT Cut-Fundamental CL 8 FL ±10 TR -30 to +85 F/T ±10 10 150 ESR 30 C0 5 ±3 -55 to +125	Fn 37.400000 MHz MO AT Cut-Fundamental PF CL 8 pF FL ±10 ppm TR -30 to +85 °C F/T ±10 ppm 10 μW 150 μW ESR 30 Ω C0 5 pF ±3 ppm -55 to +125 °C

* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY: (RoHS version): J-STD-002

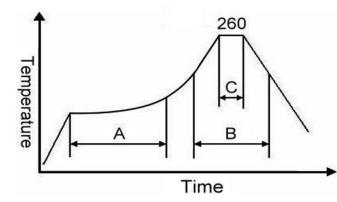
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

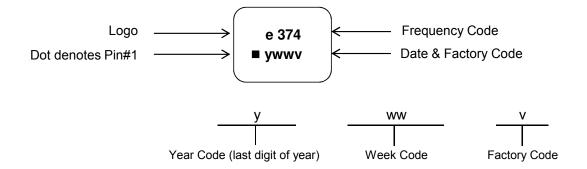
For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

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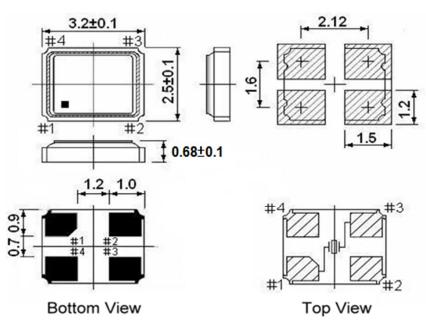
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MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

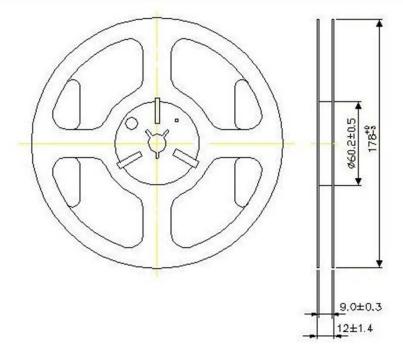


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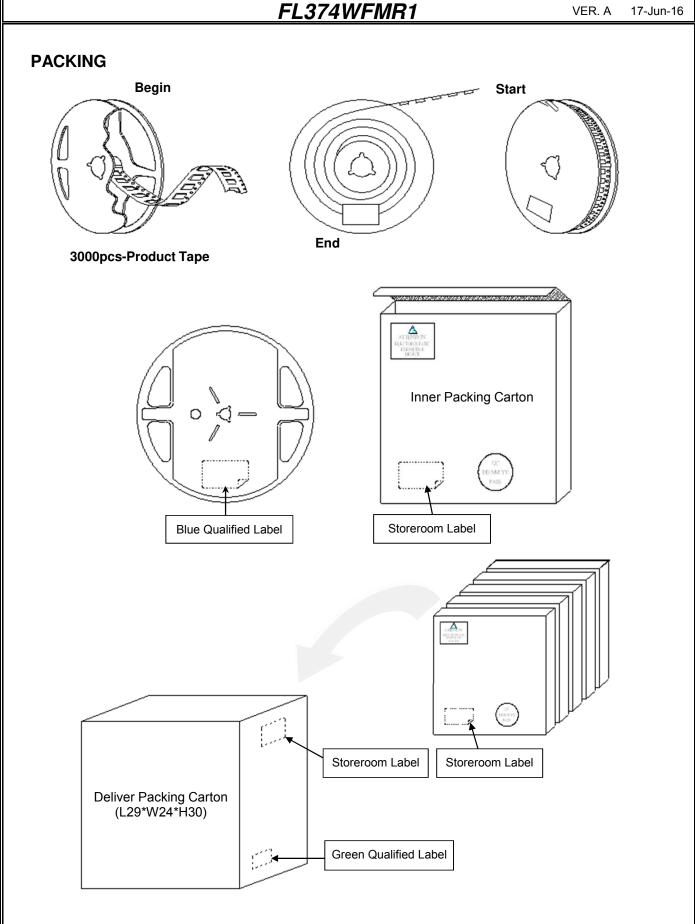
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Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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